MOSFET – POWERTRENCH[®], N-Channel

60 V, 30 A, 15 m Ω

Features

- Typical $R_{DS(on)} = 12.5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 30 \text{ A}$
- Typical $Q_{G(tot)} = 13 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 25 \text{ A}$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Started/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	60	V
V _{GS}	Gate-to-Source Voltage	±20	V
۱ _D	Drain Current – Continuous (VGS = 10) T _C = 25°C (Note 1)	30	A
	Pulsed Drain Current, $T_{C} = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	13.5	mJ
PD	Power Dissipation	50	W
	Derate Above 25°C	0.33	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C
R_{\thetaJC}	$R_{\theta JC}$ Thermal Resistance, Junction to Case		°C/W
R _{0JA} Maximum Thermal Resistance, Junction to Ambient (Note 3)		50	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

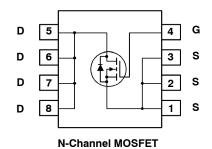
- 1. Current is limited by bondwire configuration.
- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 40\mu$ H, $I_{AS} = 26$ A, $V_{DD} = 60$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

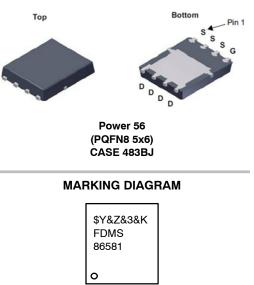


ON Semiconductor®

www.onsemi.com

ELECTRICAL CONNECTION





\$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FDMS86581	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

PACKAGE MARKING AND ORDERING INFORMATION

	Device Marking	Device	Package	Shipping [†]
ĺ	FDMS86581	FDMS86581-F085	Power 56	3000 Units/ Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур.	Max.	Units		
OFF CHARA	OFF CHARACTERISTICS								
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D=250~\mu\text{A},~V_{GS}~=0~\text{V}$		60	-	-	V		
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 60 V	$T_J = 25^{\circ}C$	-	-	1	А		
		V _{GS} = 0 V	T _J = 175°C (Note 4)	-	-	1	mA		
I _{GSS}	Gate-to-Source Leakage Current	V_{GS} = ± 20 V		-	-	±100	nA		

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} =$	= 250 μA	2.0	2.7	4.0	V
R _{DS(on)}	Drain to Source On Resistance	I _D = 30 A	$T_J = 25^{\circ}C$	-	12.5	15.0	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	-	25.1	30.1	mΩ

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz	-	881	-	pF
C _{oss}	Output Capacitance		-	281	-	pF
C _{rss}	Reverse Transfer Capacitance		-	15	-	pF
R _G	Gate Resistance	f = 1 MHz	-	3.1	-	Ω
Q _{g(ToT)}	Total Gate Charge	V _{GS} = 0 to 10 V	-	13	19	nC
Q _{g(th)}	Threshold Gate Charge	V _{GS} = 0 to 2 V	-	2	-	nC
Q _{gs}	Gate-to-Source Gate Charge	V _{DD} = 30 V I _D = 25 A	-	4	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge		-	3	-	nC

SWITCHING CHARACTERISTICS

t _{on}	Turn-On Time	V_{DD} = 30 V, I _D = 30 A V _{GS} = 10 V, R _{GEN} = 6 Ω	_	-	20	ns
t _{d(on)}	Turn-On Delay	$V_{\rm GS} = 10$ V, $\Pi_{\rm GEN} = 0.22$	-	9	-	ns
t _r	Rise Time		_	5	_	ns
t _{d(off)}	Turn-Off Delay		-	15	-	ns
t _f	Fall Time		-	4	-	ns
t _{off}	Turn-Off Time		-	-	28	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Source-to-Drain Diode Voltage	I_{SD} = 30 A, V_{GS} = 0 V	-	-	1.25	V
		I_{SD} = 15 A, V_{GS} = 0 V	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_{\rm F} = 30$ A, $dI_{\rm SD}/dt = 100$ A/ μ s,	-	37	55	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} = 48 V	-	22	33	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS

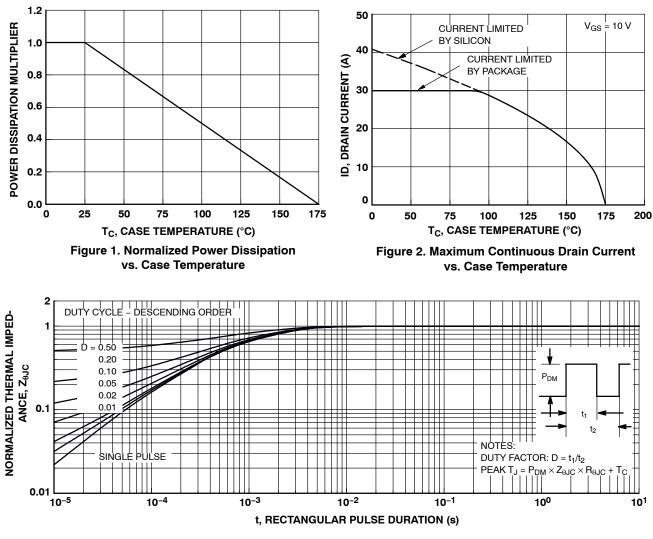
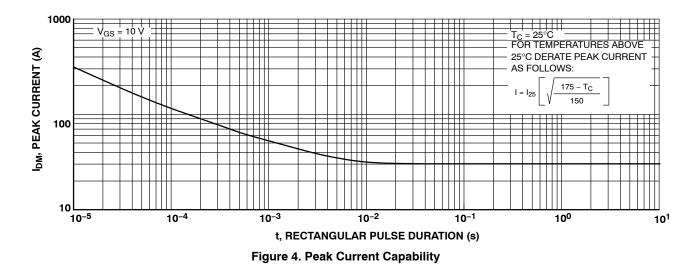
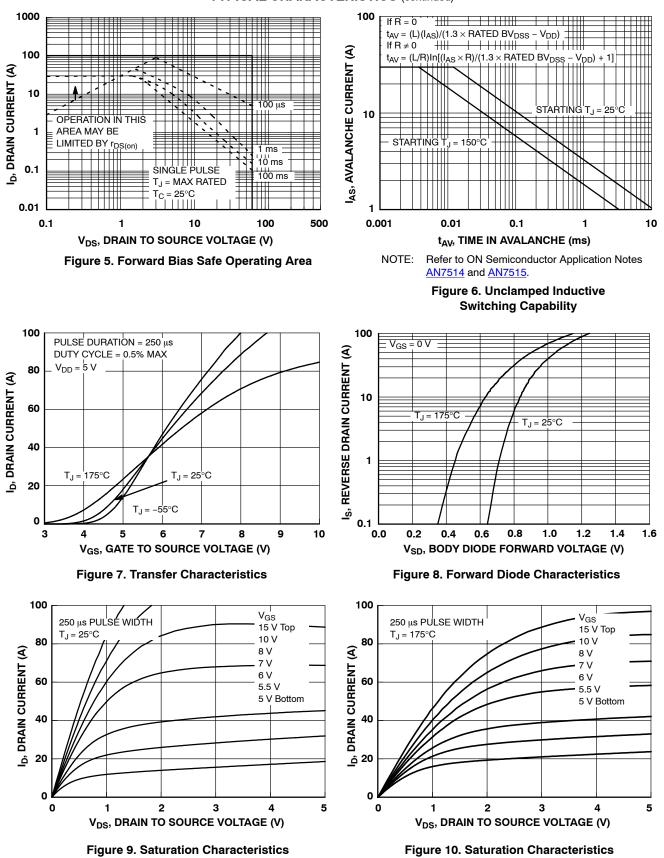


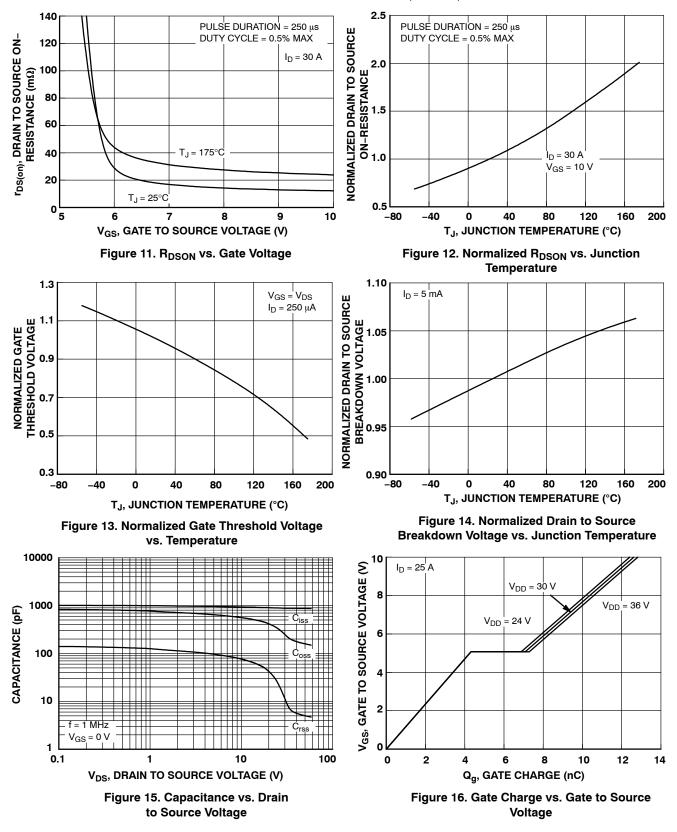
Figure 3. Normalized Maximum Transient Thermal Impedance



www.onsemi.com 3



TYPICAL CHARACTERISTICS (continued)



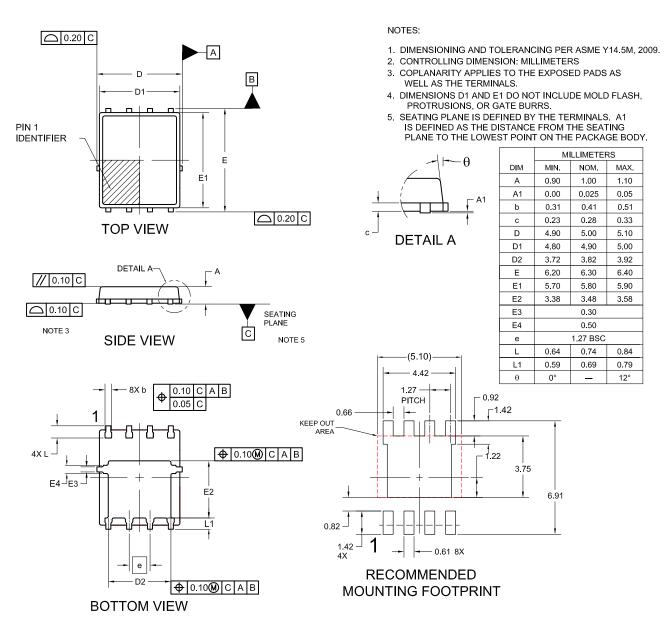
TYPICAL CHARACTERISTICS (continued)

POWERTRENCH is registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.



PQFN8 5X6, 1.27P CASE 483BJ ISSUE C

DATE 13 DEC 2017



DOCUMENT NUMBER:	98AON13688G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	PQFN8 5X6, 1.27P		PAGE 1 OF 1				
ON Semiconductor and ()) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the							

rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B